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I wish all of you health and happiness.

That statement brought great comfort to my brother and I am glad for that.

So this is hard, real hard.

If you like my buttons, please visit Cheapskate Designs! Please keep the people in Haiti & Chili in your prayers.

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bought this tube at CVS (a drugstore) for 50% off and she had no idea

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Part 1: General rules; German version EN 1997-1:2004 + AC:2009 . IEC 61935-1 Ed. 3.0:2010:2010 Project IEC 60747-14-4 Ed. 1.0:2010 Semiconductor devices

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National Voluntary Laboratory Accreditation Program IEC 61000-4-4(1995), A1(2000), A2(2001); EN 61000-4-4 IEC 60601-1-6 Ed. 2.0

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which has a publication date of 2000-11 (the first edition was published in 1972). Document#: IEC/PAS 60027-6 Ed. 1.0 en:2004 Title: